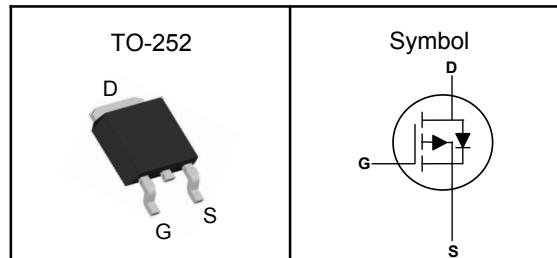


P-Channel Enhancement Mode MOSFET

Features

- Advanced trench cell design
- Low Thermal Resistance
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested

Pin Description



Applications

- Motor drivers
- DC - DC Converter

V_{DSS}	-40	V
$R_{DS(ON)-Typ}$	22	$\text{m}\Omega$
I_D	-32	A

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$, Unless Otherwise Noted)

Symbol	Parameter	Rating	Unit	
V_{DSS}	Drain-Source Voltage	-40	V	
V_{GSS}	Gate-Source Voltage	± 20	V	
T_J	Maximum Junction Temperature	-55 to 150	$^\circ\text{C}$	
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$	
$I_{DM}^{①}$	Pulse Drain Current Tested	-128	A	
I_D	Continuous Drain Current	$T_c=25^\circ\text{C}$	-32	A
P_D	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	56	W
$I_{AS}^{②}$	Avalanche Current, Single pulse	$L=0.1\text{mH}$	-26	A
$E_{AS}^{②}$	Avalanche Energy, Single pulse	$L=0.5\text{mH}$	80	mJ

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}^{③}$	Thermal Resistance-Junction to Ambient	48	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance-Junction to Case	2.2	$^\circ\text{C}/\text{W}$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C .

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz.

P-Channel Enhancement Mode MOSFET

Electrical Characteristics ($T_J=25^\circ\text{C}$, Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=-250\mu\text{A}$	-40	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=-40\text{V}$, $V_{\text{GS}}=0\text{V}$	---	---	-1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=-250\mu\text{A}$	-1.0	---	-2.0	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
$R_{\text{DS(ON)}}$	Drain-Source On-state Resistance	$V_{\text{GS}}=-10\text{V}$, $I_{\text{D}}=-12\text{A}$	---	22	28	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}$, $I_{\text{D}}=-8\text{A}$	---	27	35	$\text{m}\Omega$
Dynamic Characteristics^⑤						
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=-20\text{V}$, Freq.=1MHz	---	1836	---	pF
C_{oss}	Output Capacitance		---	270	---	
C_{rss}	Reverse Transfer Capacitance		---	185	---	
$T_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=-10\text{V}$, $V_{\text{DD}}=-20\text{V}$, $I_{\text{D}}=-20\text{A}$, $R_{\text{G}}=3\Omega$	---	12	---	nS
T_{r}	Turn-on Rise Time		---	21	---	
$T_{\text{d(off)}}$	Turn-off Delay Time		---	57	---	
T_{f}	Turn-off Fall Time		---	31	---	
Q_{g}	Total Gate Charge	$V_{\text{GS}}=-10\text{V}$, $V_{\text{DD}}=-20\text{V}$, $I_{\text{D}}=-12\text{A}$	---	43	---	nC
Q_{gs}	Gate-Source Charge		---	11	---	
Q_{gd}	Gate-Drain Charge		---	13	---	
Source-Drain Characteristics						
$V_{\text{SD}}^{④}$	Diode Forward Voltage	$I_{\text{S}}=-1\text{A}$, $V_{\text{GS}}=0\text{V}$	---	---	-1.0	V

Note ④: Pulse test (pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$).

Note ⑤ : Guaranteed by design, not subject to production testing.

P-Channel Enhancement Mode MOSFET

Typical Characteristics

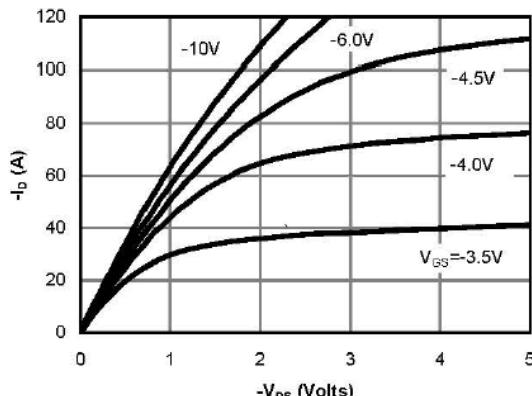


Figure 1. On-Region Characteristics

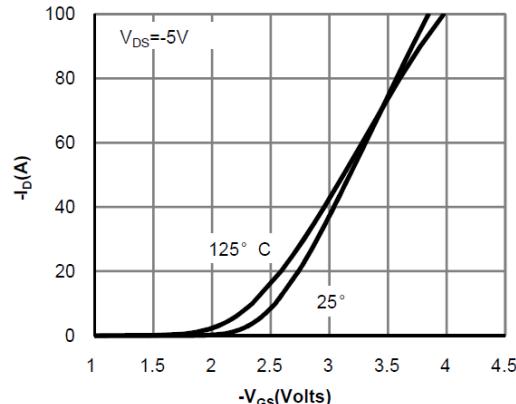


Figure 2. Transfer Characteristics

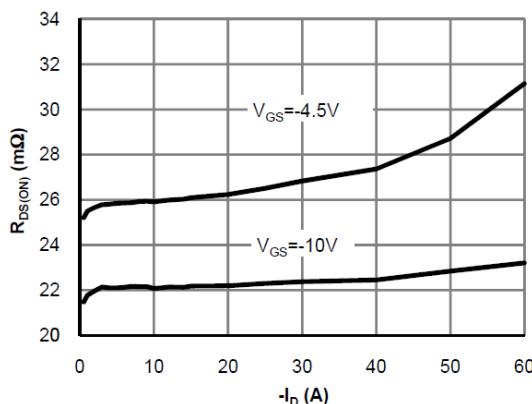


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

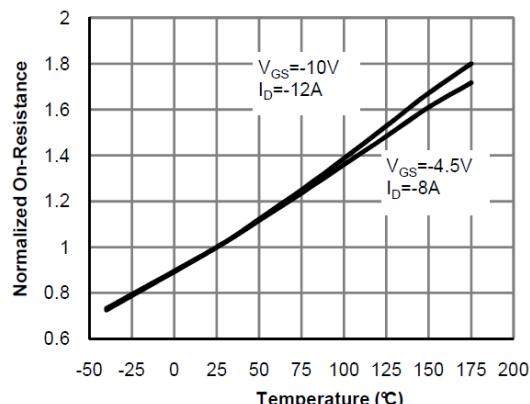


Figure 4. On-Resistance vs. Junction Temperature

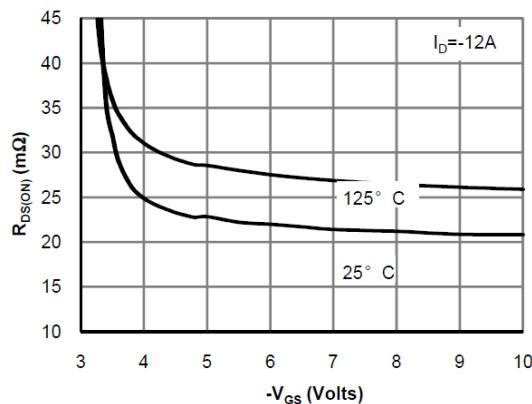


Figure 5. On-Resistance vs. Gate-Source Voltage

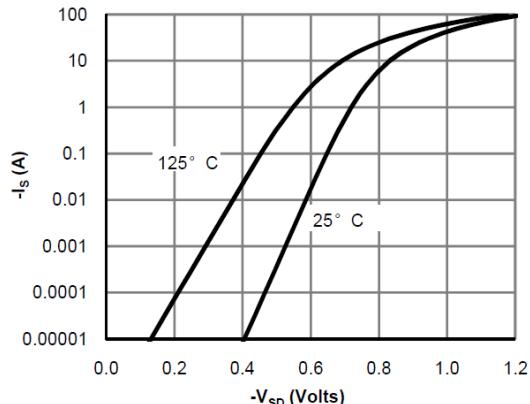


Figure 6. Body-Diode Characteristics

P-Channel Enhancement Mode MOSFET

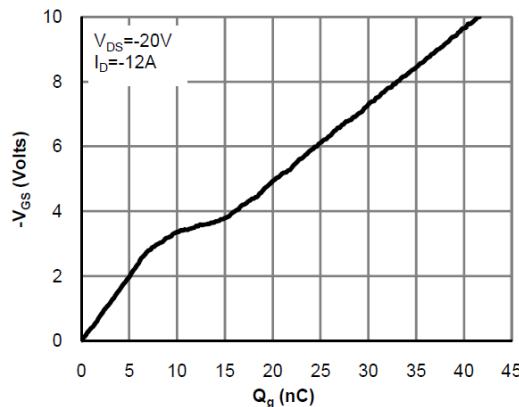


Figure 7. Gate-Charge Characteristics

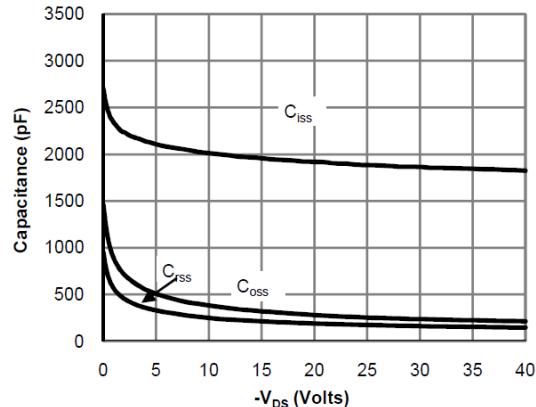


Figure 8. Capacitance Characteristics

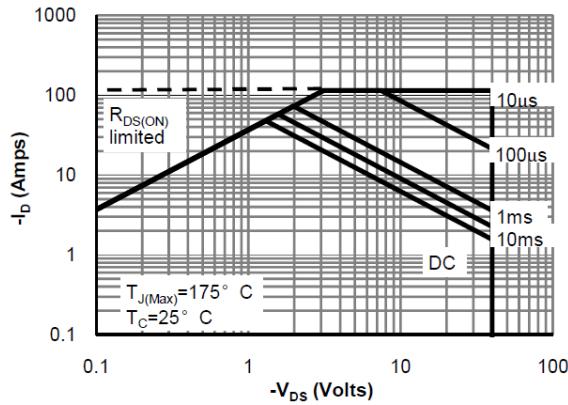


Figure 9. Maximum Forward Biased Safe Operating Area

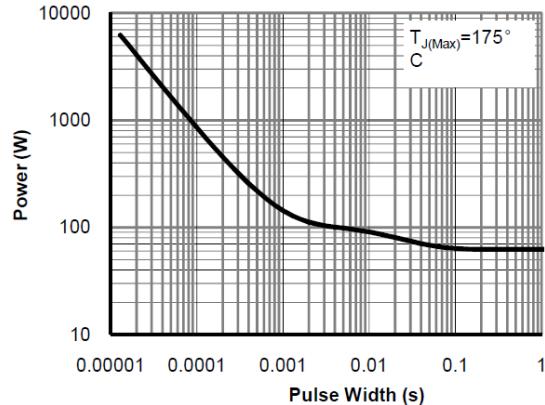


Figure 10. Single Pulse Power Rating Junction-to-Ambient

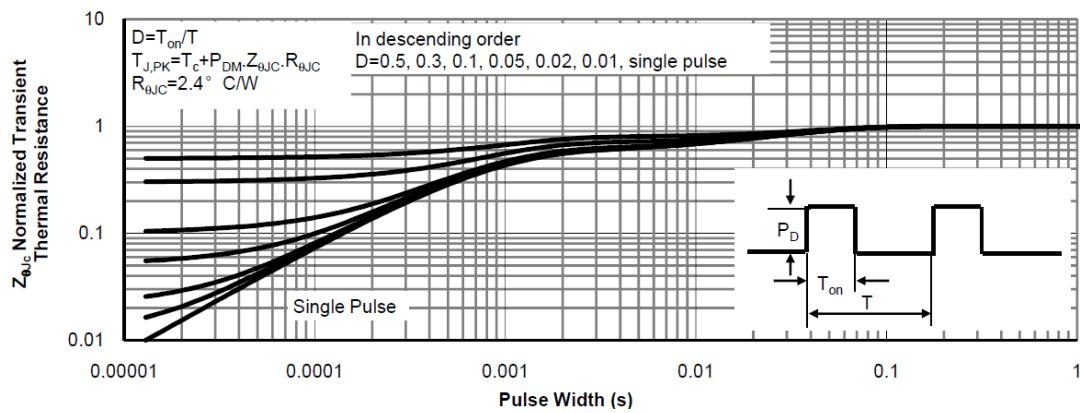
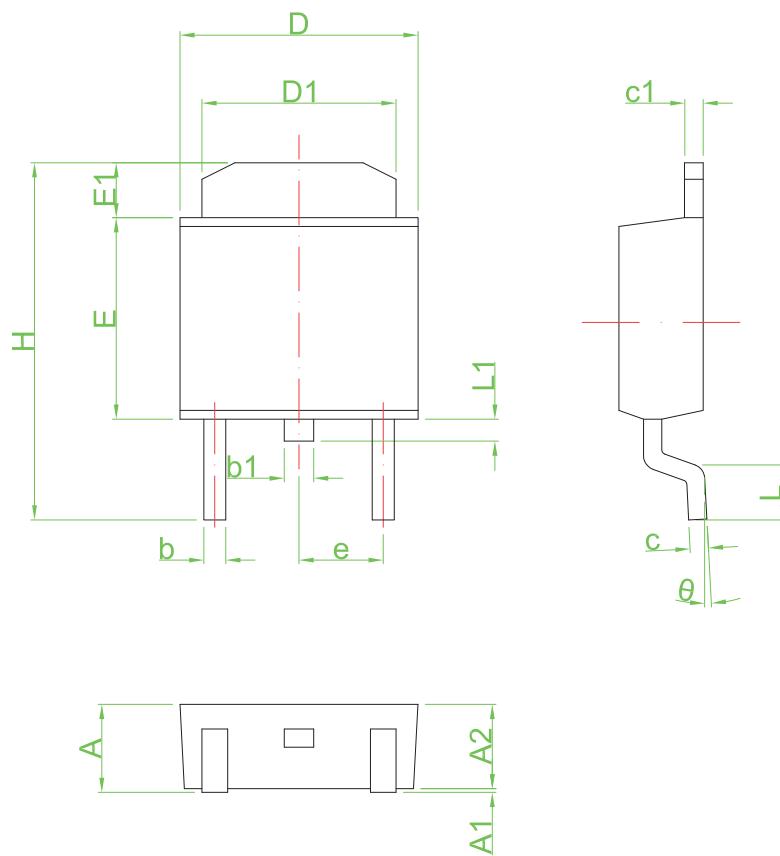


Figure 11. Normalized Maximum Transient Thermal Impedance

P-Channel Enhancement Mode MOSFET

TO-252 Package Outline Dimensions



Symbol	Dimensions in Millimeters		Dimensions in Inches	
	Min	Max	Min	Max
A	2.25	2.65	0.089	0.104
A1	0.00	0.15	0.000	0.006
A2	2.20	2.40	0.087	0.094
b	0.50	0.70	0.020	0.028
b1	0.70	0.90	0.028	0.035
c	0.46	0.66	0.018	0.026
c1	0.46	0.66	0.018	0.026
D	6.30	6.70	0.248	0.264
D1	5.20	5.40	0.205	0.213
E	5.30	5.70	0.209	0.224
E1	1.40	1.60	0.055	0.063
H	9.40	9.90	0.370	0.390
e	2.30 TYP		0.09 TYP	
L	1.40	1.77	0.055	0.070
L1	0.50	0.70	0.020	0.028
θ	0°	8°	0°	8°